

# SSM6J771G

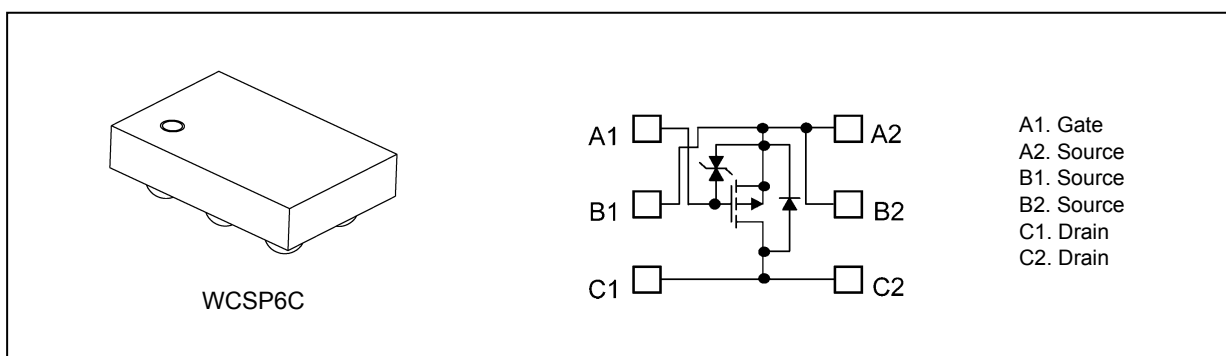
## 1. Applications

- BATFETs
- Power Management Switches

## 2. Features

- (1) High  $V_{GSS}$  voltage :  $\pm 12V$
- (2) High  $V_{DSS}$  voltage :  $-20V$
- (3) Low drain-source on-resistance  
 $R_{DS(ON)} = 26\text{ m}\Omega$  (typ.) (@ $V_{GS} = -4.5\text{ V}$ ,  $I_D = -3.0A$ )  
 $R_{DS(ON)} = 24\text{ m}\Omega$  (typ.) (@ $V_{GS} = -8.0\text{ V}$ ,  $I_D = -3.0A$ )  
 $R_{DS(ON)} = 23\text{ m}\Omega$  (typ.) (@ $V_{GS} = -8.5\text{ V}$ ,  $I_D = -3.0A$ )

## 3. Packaging and Pin Assignment



## 4. Absolute Maximum Ratings (Note) (Unless otherwise specified, $T_a = 25\text{ }^{\circ}\text{C}$ )

| Characteristics                                      | Symbol    | Rating     | Unit               |
|--|-----------|------------|--------------------|
| Drain-source voltage                                 | $V_{DSS}$ | -20        | V                  |
| Gate-source voltage                                  | $V_{GSS}$ | $\pm 12$   |                    |
| Drain current (DC) (Note 1)                          | $I_D$     | -5.0       | A                  |
| Drain current (pulsed) (Note 1), (Note 2)            | $I_{DP}$  | -10.0      |                    |
| Power dissipation (Note 3)                           | $P_D$     | 1.6        | W                  |
| Power dissipation ( $t \leq 10\text{ s}$ ) (Note 3)  | $P_D$     | 2.9        |                    |
| Power dissipation ( $t \leq 0.1\text{ s}$ ) (Note 3) | $P_D$     | 5.0        |                    |
| Channel temperature                                  | $T_{ch}$  | 150        | $^{\circ}\text{C}$ |
| Storage temperature                                  | $T_{stg}$ | -55 to 150 |                    |

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 1: Ensure that the channel temperature does not exceed  $150\text{ }^{\circ}\text{C}$ .

Note 2: Pulse width (PW)  $\leq 10\text{ ms}$ , duty  $\leq 1\%$

Note 3: Device mounted on an FR-4 board.

(40.0mm  $\times$  40.0 mm  $\times$  1.6 mm ,Cu Pad: 1369 mm<sup>2</sup> 4 layer)

Start of commercial production

2013-07

Note: The MOSFETs in this device are sensitive to electrostatic discharge. When handling this device, the worktables, operators, soldering irons and other objects should be protected against anti-static discharge.

Note: The channel-to-ambient thermal resistance,  $R_{th(ch-a)}$ , and the drain power dissipation,  $P_D$ , vary according to the board material, board area, board thickness and pad area. When using this device, be sure to take heat dissipation fully into account.

## 5. Electrical Characteristics

### 5.1. Static Characteristics (Unless otherwise specified, $T_a = 25\text{ }^{\circ}\text{C}$ )

| Characteristics                         | Symbol        | Test Condition                                     | Min  | Typ. | Max     | Unit             |
|---|---------------|--|------|------|---------|------------------|
| Gate leakage current                    | $I_{GSS}$     | $V_{GS} = \pm 10\text{ V}$ , $V_{DS} = 0\text{ V}$ | —    | —    | $\pm 1$ | $\mu\text{A}$    |
| Drain cut-off current                   | $I_{DSS}$     | $V_{DS} = -20\text{ V}$ , $V_{GS} = 0\text{ V}$    | —    | —    | -1      |                  |
| Drain-source breakdown voltage          | $V_{(BR)DSS}$ | $I_D = -1\text{ mA}$ , $V_{GS} = 0\text{ V}$       | -20  | —    | —       | V                |
| Drain-source breakdown voltage (Note 1) | $V_{(BR)DSX}$ | $I_D = -1\text{ mA}$ , $V_{GS} = 8\text{ V}$       | -12  | —    | —       |                  |
| Gate threshold voltage (Note 2)         | $V_{th}$      | $V_{DS} = -3\text{ V}$ , $I_D = -1\text{ mA}$      | -0.5 | —    | -1.2    |                  |
| Drain-source on-resistance (Note 3)     | $R_{DS(ON)}$  | $I_D = -3.0\text{ A}$ , $V_{GS} = -8.5\text{ V}$   | —    | 23   | 31      | $\text{m}\Omega$ |
|   |               | $I_D = -3.0\text{ A}$ , $V_{GS} = -8.0\text{ V}$   | —    | 24   | 34.7    |                  |
|   |               | $I_D = -3.0\text{ A}$ , $V_{GS} = -4.5\text{ V}$   | —    | 26   | 35      |                  |
|   |               | $I_D = -2.5\text{ A}$ , $V_{GS} = -2.5\text{ V}$   | —    | 37   | 47.5    | $\text{m}\Omega$ |
| Forward transfer admittance (Note 3)    | $ Y_{fs} $    | $V_{DS} = -3\text{ V}$ , $I_D = -3.0\text{ A}$     | —    | 19.0 | —       | S                |

Note 1: If a reverse bias is applied between gate and source, this device enters  $V_{(BR)DSX}$  mode. Note that the drain-source breakdown voltage is lowered in this mode.

Note 2: Let  $V_{th}$  be the voltage applied between gate and source that causes the drain current ( $I_D$ ) to below (-1 mA for this device). Then, for normal switching operation,  $V_{GS(ON)}$  must be higher than  $V_{th}$ , and  $V_{GS(OFF)}$  must be lower than  $V_{th}$ . This relationship can be expressed as:  $V_{GS(OFF)} < V_{th} < V_{GS(ON)}$ .

Take this into consideration when using the device.

Note 3: Pulse measurement.

### 5.2. Dynamic Characteristics (Unless otherwise specified, $T_a = 25\text{ }^{\circ}\text{C}$ )

| Characteristics                | Symbol    | Test Condition  | Min | Typ. | Max | Unit        |
|--------------------------------|-----------|---|-----|------|-----|-------------|
| Input capacitance              | $C_{iss}$ | $V_{DS} = -10\text{ V}$ , $V_{GS} = 0\text{ V}$ ,<br>$f = 1\text{ MHz}$   | —   | 870  | —   | $\text{pF}$ |
| Reverse transfer capacitance   | $C_{rss}$ |   | —   | 120  | —   |             |
| Output capacitance             | $C_{oss}$ |   | —   | 150  | —   |             |
| Switching time (turn-on time)  | $t_{on}$  | $V_{DD} = -10\text{ V}$ , $I_D = -1\text{ A}$<br>$V_{GS} = 0\text{ to } -8.0\text{ V}$ , $R_G = 20\text{ }\Omega$<br>See Chapter 5.3. | —   | 28   | —   | ns          |
| Switching time (turn-off time) | $t_{off}$ | $V_{DD} = -10\text{ V}$ , $I_D = -1\text{ A}$<br>$V_{GS} = 0\text{ to } -8.0\text{ V}$ , $R_G = 20\text{ }\Omega$<br>See Chapter 5.3. | —   | 90   | —   |             |

### 5.3. Switching Time Test Circuit

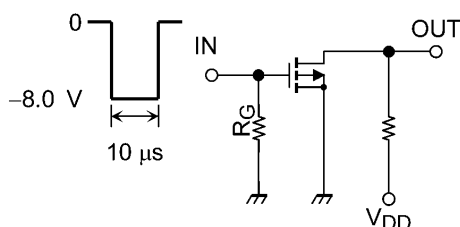


Fig. 5.3.1 Switching Time Test Circuit

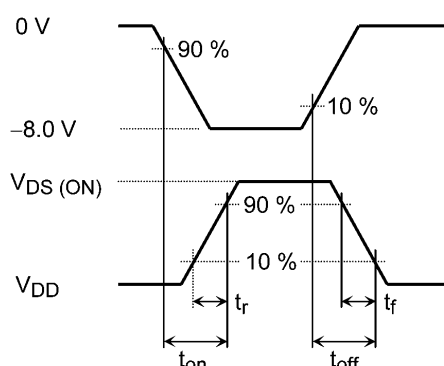


Fig. 5.3.2 Input Waveform/Output Waveform

#### 5.4. Gate Charge Characteristics (Unless otherwise specified, $T_a = 25\text{ }^{\circ}\text{C}$ )

| Characteristics                                 | Symbol    | Test Condition  | Min | Typ. | Max | Unit |
|---|-----------|---|-----|------|-----|------|
| Total gate charge (gate-source plus gate-drain) | $Q_g$     | $V_{DD} = -10\text{ V}$ , $V_{GS} = -4.5\text{ V}$ ,<br>$I_D = -5.0\text{ A}$ | —   | 9.8  | —   | nC   |
| Gate-source charge 1                            | $Q_{gs1}$ |   | —   | 1.5  | —   |      |
| Gate-drain charge                               | $Q_{gd}$  |   | —   | 2.7  | —   |      |

#### 5.5. Source-Drain Characteristics (Unless otherwise specified, $T_a = 25\text{ }^{\circ}\text{C}$ )

| Characteristics                | Symbol    | Test Condition                               | Min | Typ. | Max | Unit |
|--------------------------------|-----------|--|-----|------|-----|------|
| Diode forward voltage (Note 1) | $V_{DSF}$ | $I_D = 5.0\text{ A}$ , $V_{GS} = 0\text{ V}$ | —   | 0.8  | 1.3 | V    |

Note 1: Pulse measurement.

### 6. Marking

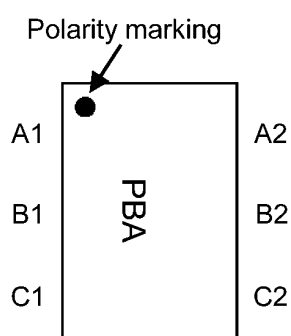


Fig. 6.1 Marking

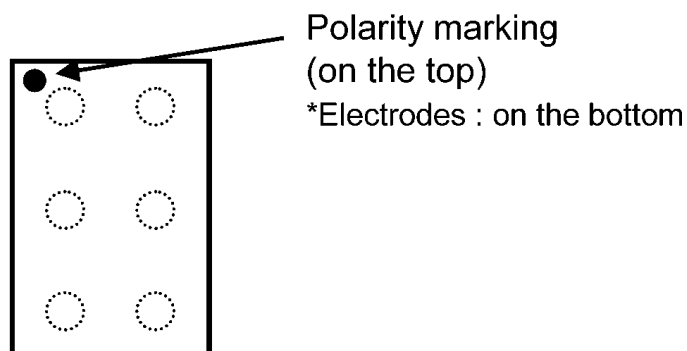
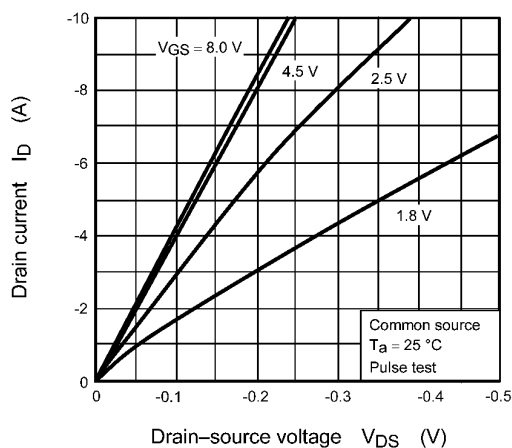
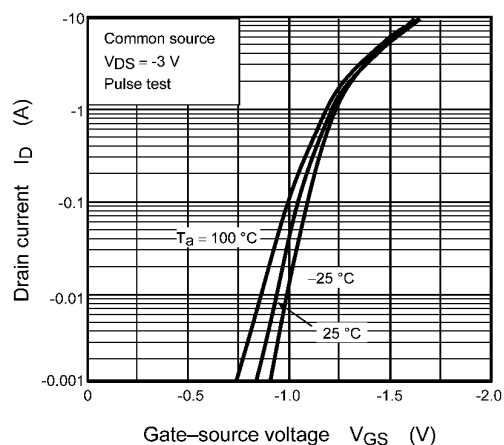


Fig. 6.2 Pin Condition(Top View)

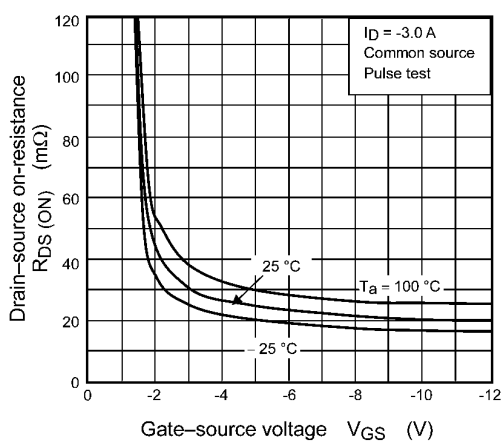
# 7. Characteristics Curves (Note)



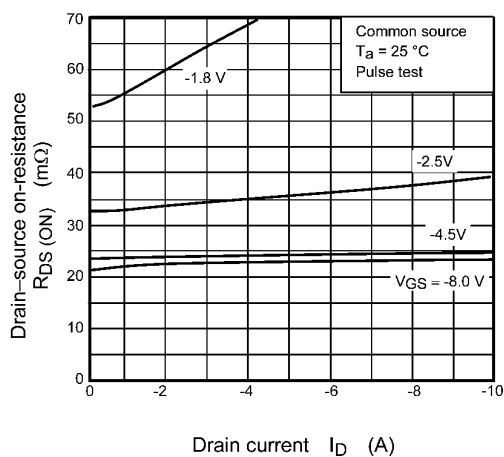
**Fig. 7.1  $I_D - V_{DS}$**



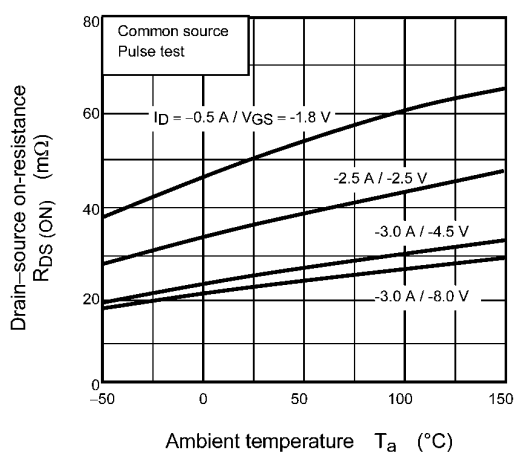
**Fig. 7.2  $I_D - V_{GS}$**



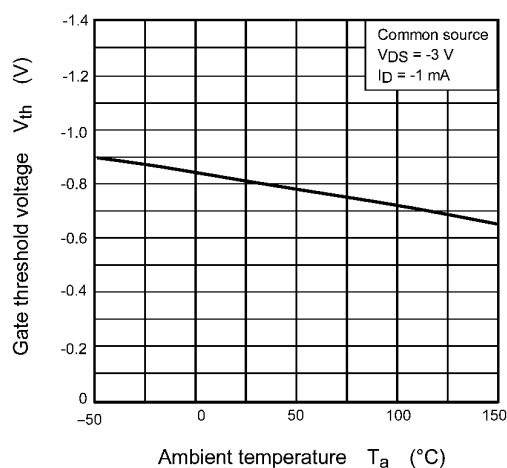
**Fig. 7.3  $R_{DS(ON)} - V_{GS}$**



**Fig. 7.4  $R_{DS(ON)} - I_D$**



**Fig. 7.5  $R_{DS(ON)} - T_a$**



**Fig. 7.6  $V_{th} - T_a$**

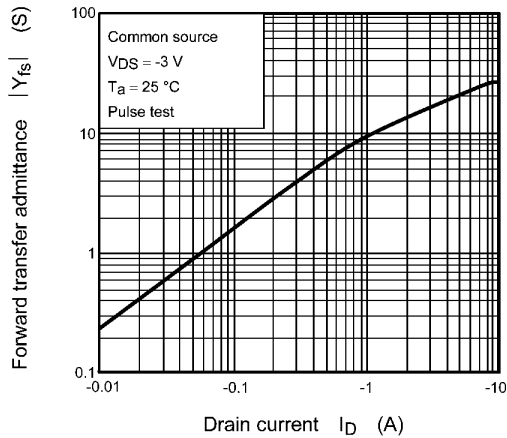


Fig. 7.7  $|Y_{fs}| - I_D$

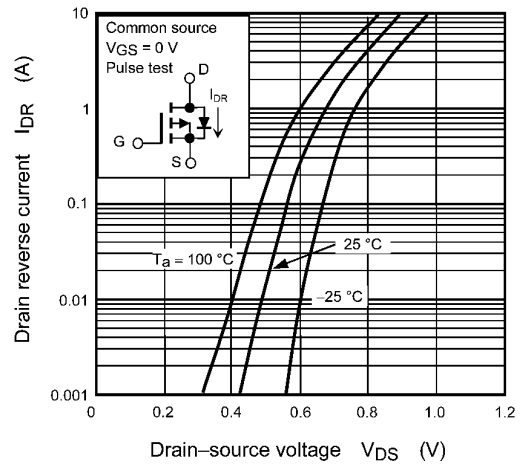


Fig. 7.8  $I_{DR} - V_{DS}$

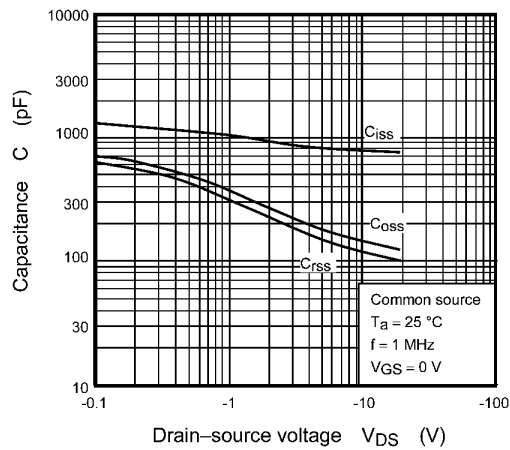


Fig. 7.9  $C - V_{DS}$

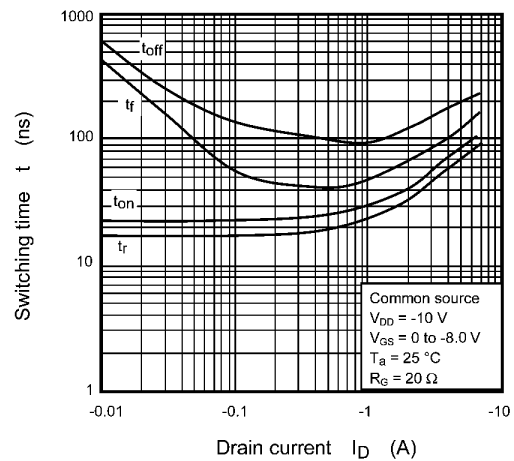


Fig. 7.10  $t - I_D$

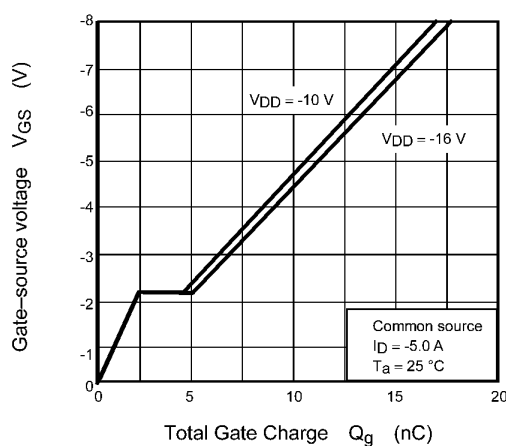


Fig. 7.11 Dynamic Input Characteristics

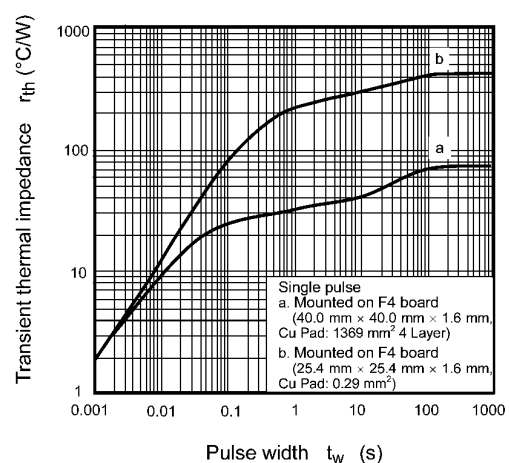
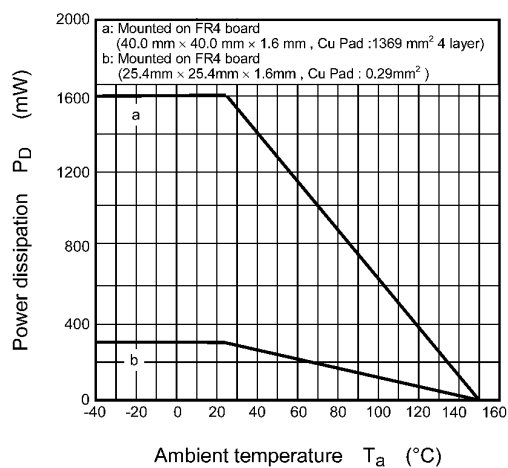


Fig. 7.12  $r_{th} - t_w$

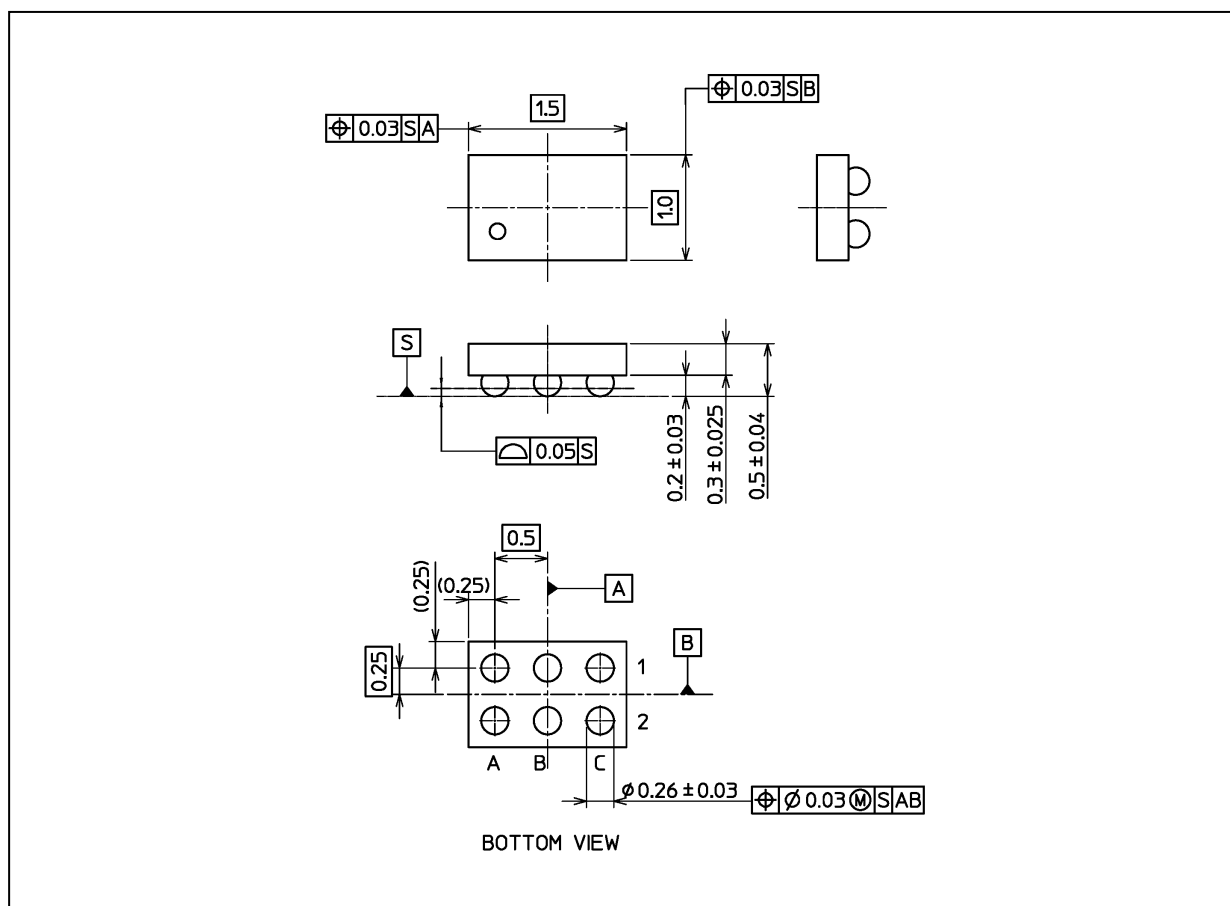


**Fig. 7.13  $P_D - T_a$**

Note: The above characteristics curves are presented for reference only and not guaranteed by production test, unless otherwise noted.

## Package Dimensions

Unit: mm



Weight: 1.4 mg (typ.)

| Package Name(s)  |
|------------------|
| Nickname: WCSP6C |



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